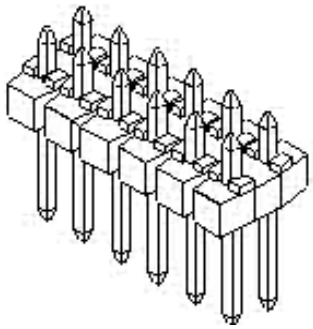


Part Number : 901310960
Product Description : 2.54mm Pitch C-Grid III Header, Dual Row, Vertical, 80 Circuits, 0.76µm Gold (Au) Selective Plating
Series Number : 90131
Status : Active
Product Category : PCB Headers and Receptacles

Documents and Resources

Drawings

901310960_sd.pdf

PK-90131-0001-000.pdf

3D Models and Design Files

STEP AP242

SOLIDWORKS

Creo

Symbol and Footprint (Multi-Format)

Specifications

901190001-AS-000.pdf

PS-99020-0001-001.pdf

Product Environment Compliance

Compliance

GADSL/IMDS	Compliant with Exemption 44; 34; 33
China RoHS	per SJ/T 11365-2006
EU ELV	Not Relevant
Low-Halogen Status	Not Low-Halogen per IEC 61249-2-21
REACH SVHC	Not Contained per D(2025)7771-DC (04 Feb 2026)
EU RoHS	Compliant per EU 2015/863

Compliance Statements

- EU RoHS

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- REACH SVHC
- Low-Halogen

Industry Documents

- IPC 1752A Class C
- IPC 1752A Class D
- Molex Product Compliance Declaration
- IEC-62474
- chemSHERPA (xml)

Substances of Interest

- PFAS

EU RoHS Certificate of Compliance

Additional Product Compliance Information

Part Details

General

Status	Active
Category	PCB Headers and Receptacles
Series	90131
Description	2.54mm Pitch C-Grid III Header, Dual Row, Vertical, 80 Circuits, 0.76µm Gold (Au) Selective Plating
Application	Wire-to-Board
Component Type	PCB Header
Product Name	C-Grid III
UPC	800753695849

Agency

CSA	LR19980
UL	E29179

Electrical

Current - Maximum per Contact	3.0A
Voltage - Maximum	350V

Physical

Breakaway	Yes

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Circuits (Loaded)	80
Circuits (maximum)	80
Color - Resin	Black
First Mate / Last Break	No
Gender	Male
Glow-Wire Capable	No
Guide to Mating Part	No
Keying to Mating Part	No
Lock to Mating Part	No
Material - Metal	Brass
Material - Plating Mating	Gold
Material - Plating Termination	Tin
Material - Resin	Polyester
Mounting Style	Through Hole
Net Weight	4.923/g
Number of Rows	2
Orientation	Vertical
Packaging Type	Tray
PCB Locator	No
PCB Retention	No
PC Tail Length	2.90mm
Pitch - Mating Interface	2.54mm
Pitch - Termination Interface	2.54mm
Plating min - Mating	0.760µm
Plating min - Termination	3.000µm
Polarized to Mating Part	No
Polarized to PCB	No
Shrouded	Unshrouded
Stackable	Yes
Temperature Range - Operating	-55° to +125°C
Termination Interface Style	Through Hole

Solder Process Data

Lead-Free Process Capability	WAVE

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Mates With / Use With

Mates with Part(s)

Description	Part Number
C-Grid III Vertical Dual Row PC Board Connectors	90151
C-Grid III Right-Angle Dual Row PC Board Connectors	90152
C-Grid III Dual Row Crimp Housings	90142
C-Grid III Modular Dual Row Crimp Housings	90143

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